

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
JIN HO KIM	12/14/2017
TAE GYOUNG KANG	12/14/2017
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	DOSILICON CO., LTD.
<b>Street Address:</b>	ROOM NO.203/03, BUILDING 1, 498 GUOSHOUJING ROAD, ZHANGJIANG HIGH-TECH PARK
<b>City:</b>	SHANGHAI
<b>State/Country:</b>	CHINA
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	15843516
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<b>ATTORNEY DOCKET NUMBER:</b>	DAE-0059-SE
<b>NAME OF SUBMITTER:</b>	JAE Y. PARK
<b>SIGNATURE:</b>	/Jae Y. Park/
<b>DATE SIGNED:</b>	12/15/2017
This document serves as an Oath/Declaration (37 CFR 1.63).	
<b>Total Attachments: 3</b>	
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COMBINED DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION  
USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT

<p>Title of Invention</p>	<p>NAND FLASH MEMORY DEVICE HAVING FACING BAR AND METHOD OF FABRICATING THE SAME</p>
<p>As the below named inventor, I hereby declare that:</p> <p>This declaration is directed to:</p> <p><input checked="" type="checkbox"/> The attached application,</p> <p><input type="checkbox"/> United States application number _____ filed on _____, or</p> <p><input type="checkbox"/> PCT international application number _____ filed on _____.</p> <p>The above-identified application was made or authorized to be made by me.</p> <p>I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.</p> <p>I have reviewed and understand the contents of the above-identified application, including the claims. I am aware of the duty to disclose information which is material to patentability as defined in 37 CFR 1.56.</p> <p>I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.</p> <p>WHEREAS, <u>DOSILICON CO., LTD.</u>, of <u>Room No.203/03, building 1, 498 GuoShouJing Road, Zhangjiang High-tech Park, Shanghai, People's Republic of China</u>, its heirs, successors, legal representatives and assigns (hereinafter referred to as "ASSIGNEE") is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent(s) that may be granted therefore in the United States of America and in any foreign countries.</p> <p>NOW, THEREFORE, to all whom it may concern, be it known that, for good and valuable consideration paid to the undersigned, the receipt of which is hereby acknowledged, I have sold, assigned and transferred, and by these presents does sell, assign and transfer unto the Assignee the full and exclusive right to the said invention in the United States of America, its territories, dependencies and possessions and the entire right, title and interest in and to any and all Letters Patent(s) which may be granted therefore in the United States of America, its territories, dependencies and possessions, and in any and all foreign countries;</p>	

Atty Docket No. DAE-0059-SE

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LEGAL NAME OF INVENTOR

Inventor: Tae Gyoung KANG  
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Citizenship: Republic of Korea  
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Date: 14 Dec, 2017

Signature: Kang

Atty Docket No. DAE-0059-SE

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